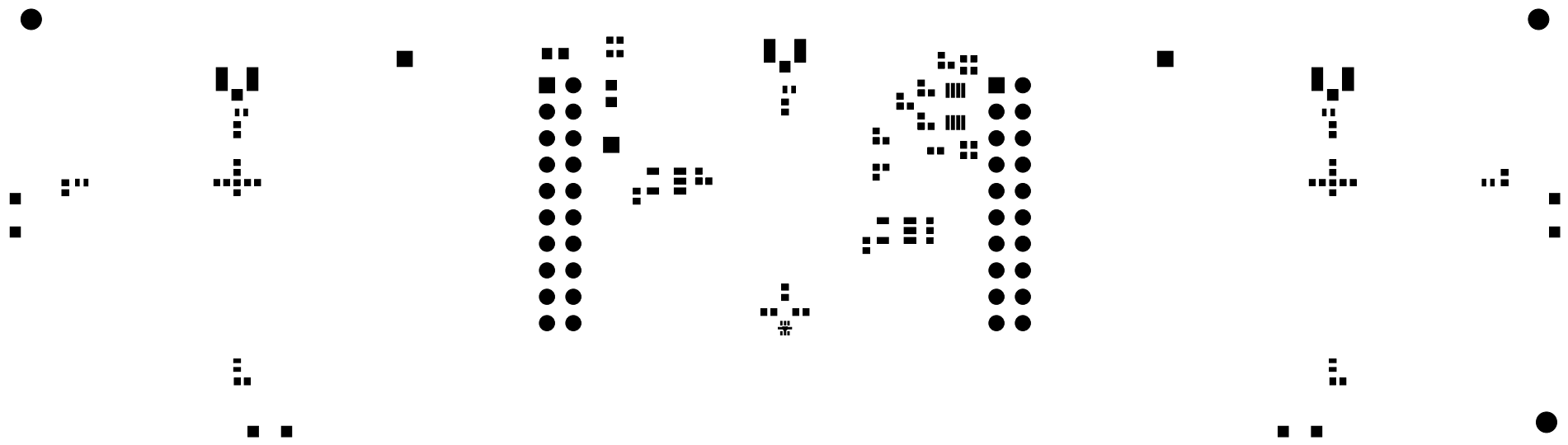


COMPANY NAME : TEXAS INSTRUMENTS	
DATE : MAY 30 2014	JOB NUMBER : TS10043
DESIGNED BY : TESSOLVE	
PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A	
FILM LAYER : PRIMARY SIDE SILKSCREEN	



COMPANY NAME : TEXAS INSTRUMENTS

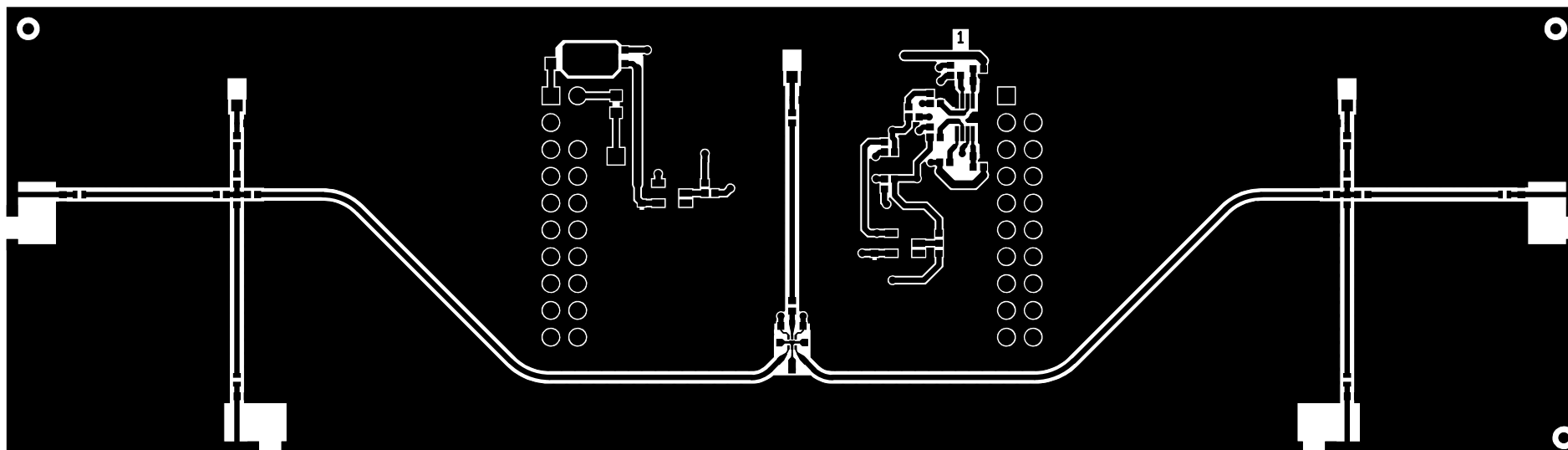
DATE : MAY 30 2014

JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : PRIMARY SIDE SOLDERMASK



COMPANY NAME : TEXAS INSTRUMENTS

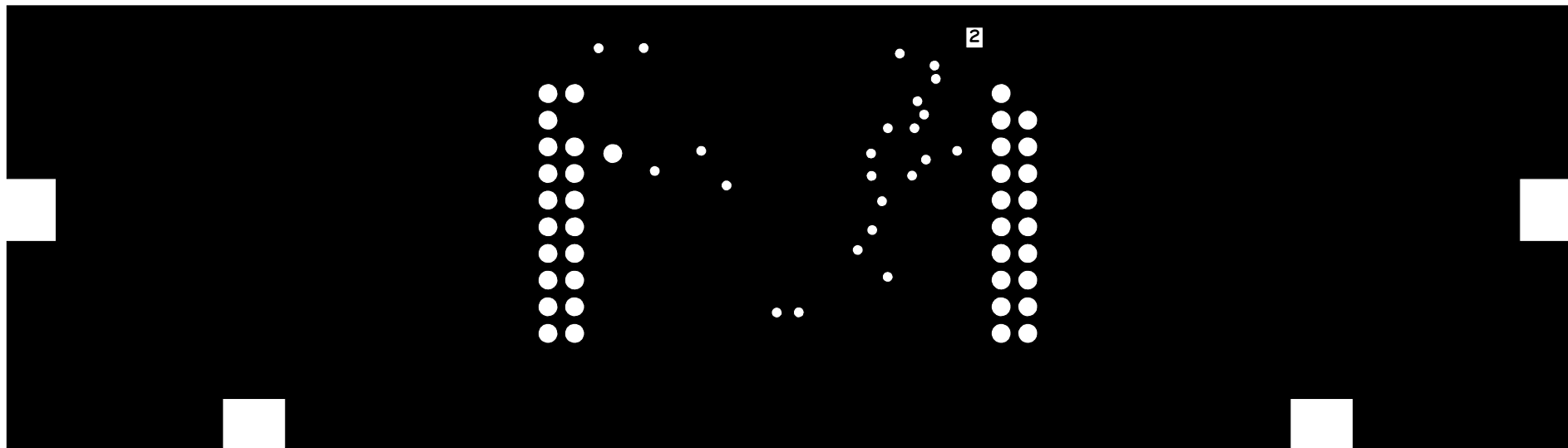
DATE : MAY 30 2014

JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : PRIMARY SIDE



COMPANY NAME : TEXAS INSTRUMENTS

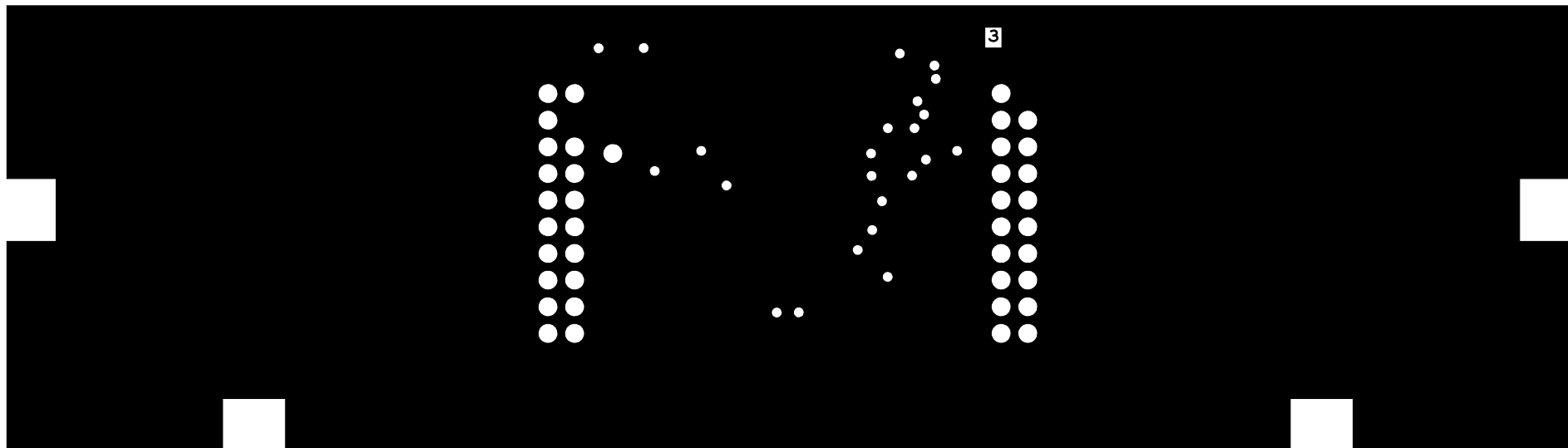
DATE : MAY 30 2014

JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : LAYER 2 ( GND )



COMPANY NAME : TEXAS INSTRUMENTS

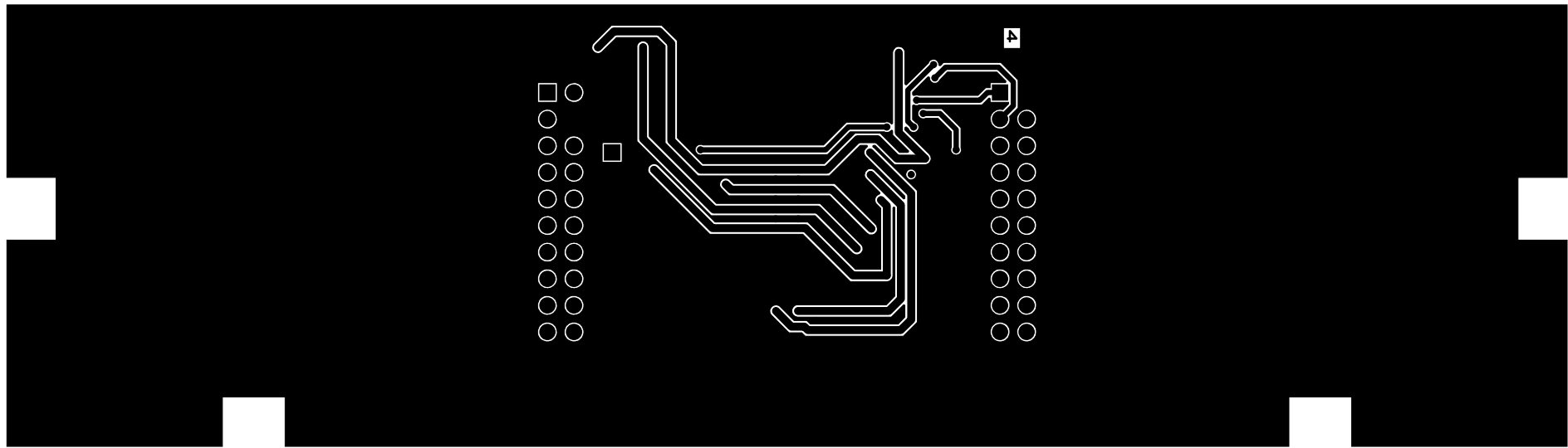
DATE : MAY 30 2014

JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : LAYER 3 (GND)



COMPANY NAME : TEXAS INSTRUMENTS

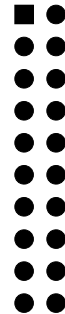
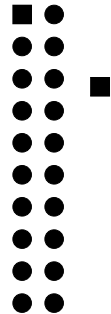
DATE : MAY 30 2014

JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : LAYER 4 ( BOTTOM SIDE )"



COMPANY NAME : TEXAS INSTRUMENTS

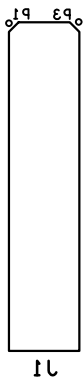
DATE : MAY 30 2014

JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : SECONDARY SIDE SOLDERMASK



For CC3100B021 and CC3500-LANCHX1 JXHNUAJ-00SECC bnd T200B001ECC 107

COMPANY NAME : TEXAS INSTRUMENTS

DATE : MAY 30 2014

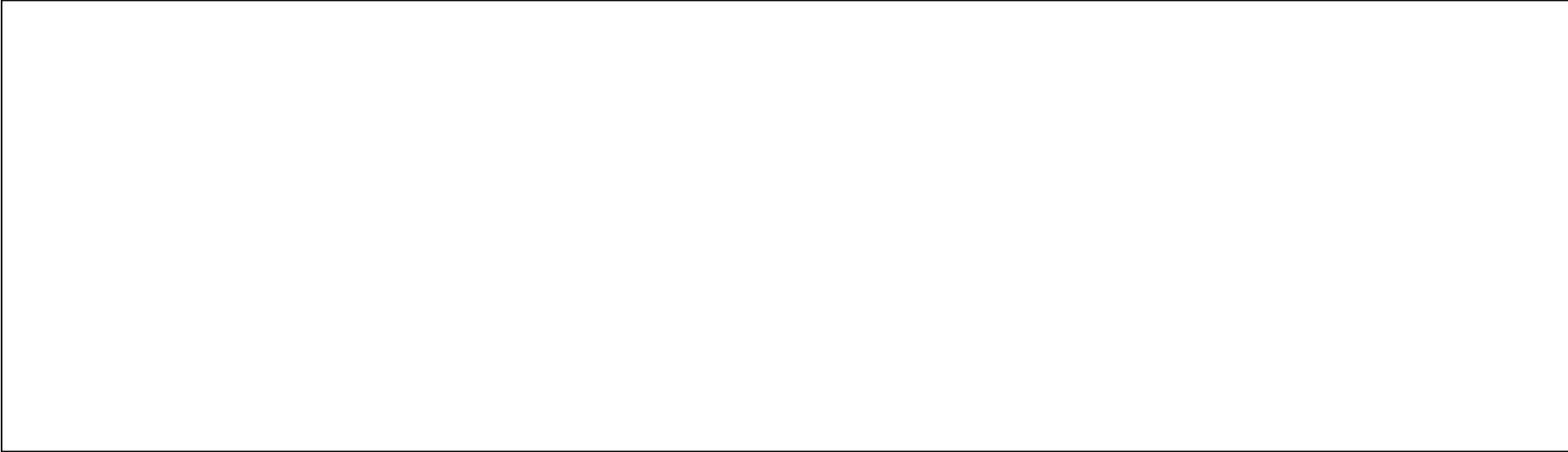
JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : SECONDARY SIDE SILKSCREEN





COMPANY NAME : TEXAS INSTRUMENTS

DATE : MAY 30 2014

JOB NUMBER : TS10043

DESIGNED BY : TESSOLVE

PART NO/CARD REF : CC3200 ANTENNA SELECTION BOOSTERPACK REV 2.0-A

FILM LAYER : OUTLINE

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